Semiconductor Equipment Association of Japan
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Web https://www.seaj.or.jp

October 2026 Billings

(Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.
Mark your calendars. **The November Report SEAJ's Web site update** is scheduled on 18th **December** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts October 2026 Billings of ¥ 598,421 million

Tokyo Japan, November 20th, 2026 JAPAN-based manufacturers of semiconductor equipment posted **¥598,421 million** in billings in October 2026(three-month average basis) published today by SEAJ.

The billings figure is **4.9 percent down** the final September 2026 level of ¥629,040 million and **44.6 percent up** the 2025 October billings level of ¥413,876 million.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
May 2026	526,352	3.2%	17.9%
June 2026	513,610	-2.4%	26.9%
July 2026	556,220	8.3%	35.4%
August 2026	597,915	7.5%	47.4%
September 2026(final)	629,040	5.2%	48.2%
October 2026(prelim)	598,421	-4.9%	44.6%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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